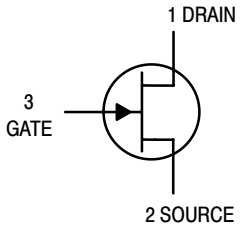
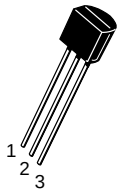
JFET Switching
N–Channel — Depletion



2N5555

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain–Source Voltage	V_{DS}	25	Vdc
Drain–Gate Voltage	V_{DG}	25	Vdc
Gate–Source Voltage	V_{GS}	25	Vdc
Forward Gate Current	I_{GF}	10	mAdc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	350 2.8	mW mW/°C
Junction Temperature Range	T_J	–65 to +150	°C
Storage Temperature Range	T_{stg}	–65 to +150	°C



CASE 29–11, STYLE 5
TO–92 (TO–226AA)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Gate–Source Breakdown Voltage (I_G = 10 μAdc, V_{DS} = 0)	$V_{(BR)GSS}$	25	—	Vdc
Gate Reverse Current (V_{GS} = 15 Vdc, V_{DS} = 0)	I_{GSS}	—	1.0	nAdc
Drain Cutoff Current (V_{DS} = 12 Vdc, V_{GS} = –10 V) (V_{DS} = 12 Vdc, V_{GS} = –10 V, T_A = 100°C)	$I_{D(off)}$	— —	10 2.0	nAdc μAdc
ON CHARACTERISTICS				
Zero–Gate–Voltage Drain Current(1) (V_{DS} = 15 Vdc, V_{GS} = 0)	I_{DSS}	15	—	mAdc
Gate–Source Forward Voltage ($I_{G(f)}$ = 1.0 mAdc, V_{DS} = 0)	$V_{GS(f)}$	—	1.0	Vdc
Drain–Source On–Voltage (I_D = 7.0 mAdc, V_{GS} = 0)	$V_{DS(on)}$	—	1.5	Vdc
Static Drain–Source On Resistance (I_D = 0.1 mAdc, V_{GS} = 0)	$r_{DS(on)}$	—	150	Ohms

1. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 3.0%.

SMALL–SIGNAL CHARACTERISTICS

Small–Signal Drain–Source “ON” Resistance (V_{GS} = 0, I_D = 0, f = 1.0 kHz)	$r_{ds(on)}$	—	150	Ohms
Input Capacitance (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 MHz)	C_{iss}	—	5.0	pF
Reverse Transfer Capacitance (V_{DS} = 0, V_{GS} = 10 Vdc, f = 1.0 MHz)	C_{rss}	—	1.2	pF

SWITCHING CHARACTERISTICS

Turn–On Delay Time	(V_{DD} = 10 Vdc, $I_{D(on)}$ = 7.0 mAdc, $V_{GS(on)}$ = 0, $V_{GS(off)}$ = –10 Vdc) (See Figure 1)	$t_{d(on)}$	—	5.0	ns
Rise Time		t_r	—	5.0	ns
Turn–Off Delay Time	(V_{DD} = 10 Vdc, $I_{D(on)}$ = 7.0 mAdc, $V_{GS(on)}$ = 0, $V_{GS(off)}$ = –10 Vdc) (See Figure 1)	$t_{d(off)}$	—	15	ns
Fall Time		t_f	—	10	ns

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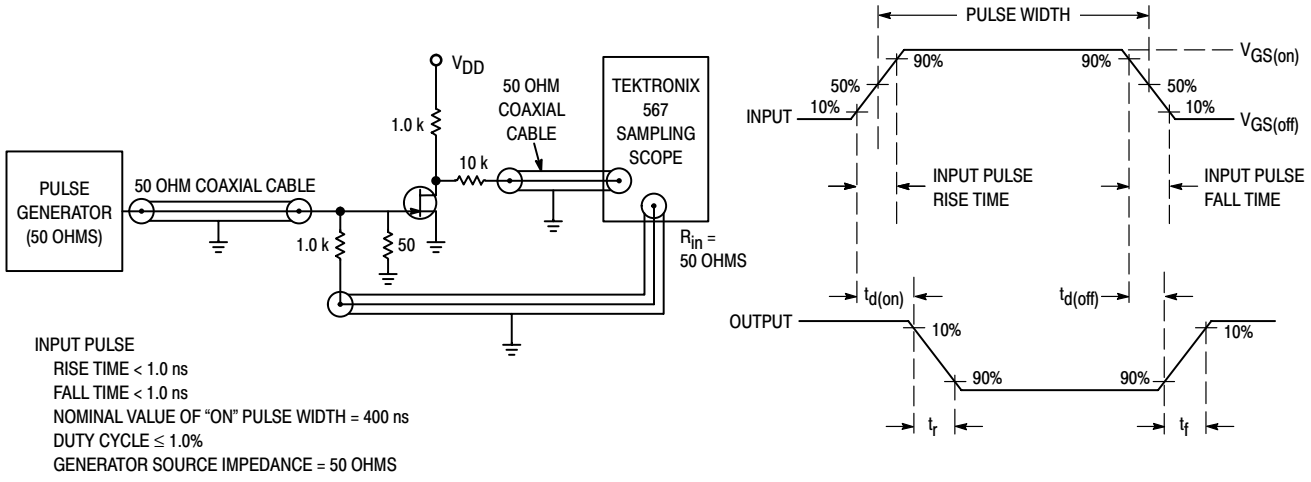


Figure 1. Switching Times Test Circuit

COMMON SOURCE CHARACTERISTICS

ADMITTANCE PARAMETERS

(V_{DS} = 15 Vdc, $T_{channel}$ = 25°C)

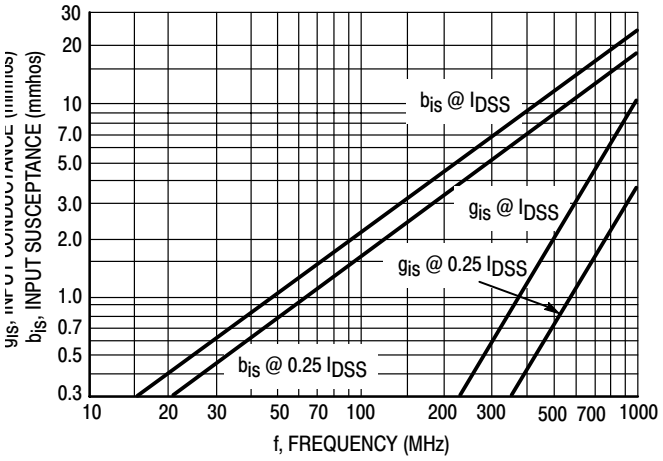


Figure 2. Input Admittance (y_{is})

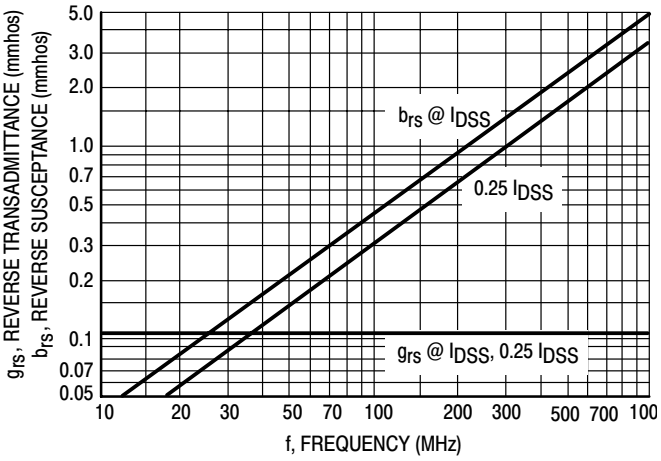


Figure 3. Reverse Transfer Admittance (y_{rs})

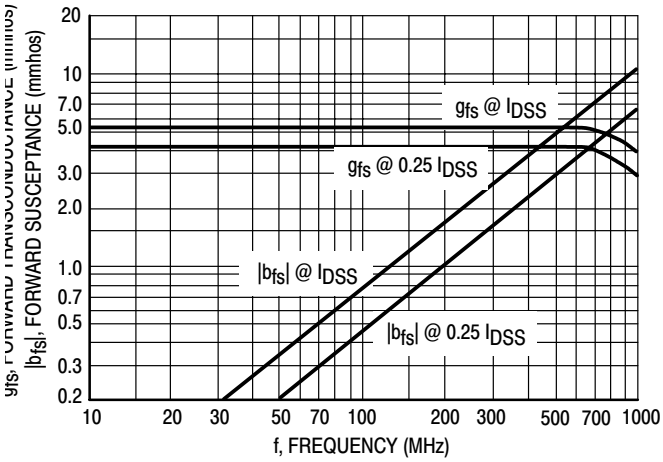


Figure 4. Forward Transadmittance (y_{fs})

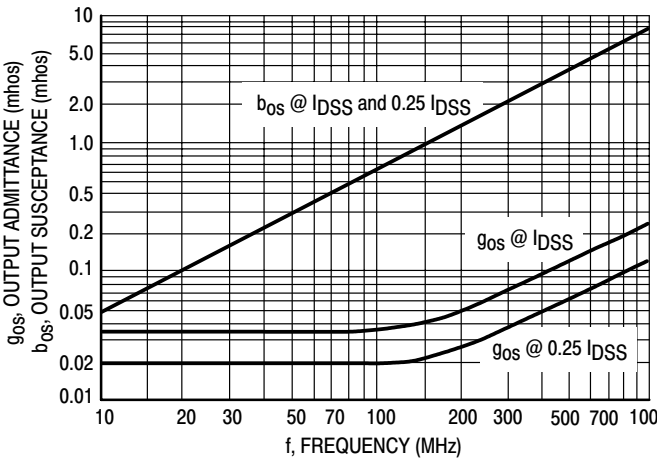


Figure 5. Output Admittance (y_{os})

COMMON SOURCE CHARACTERISTICS

S–PARAMETERS

(V_{DS} = 15 Vdc, $T_{channel}$ = 25°C, Data Points in MHz)

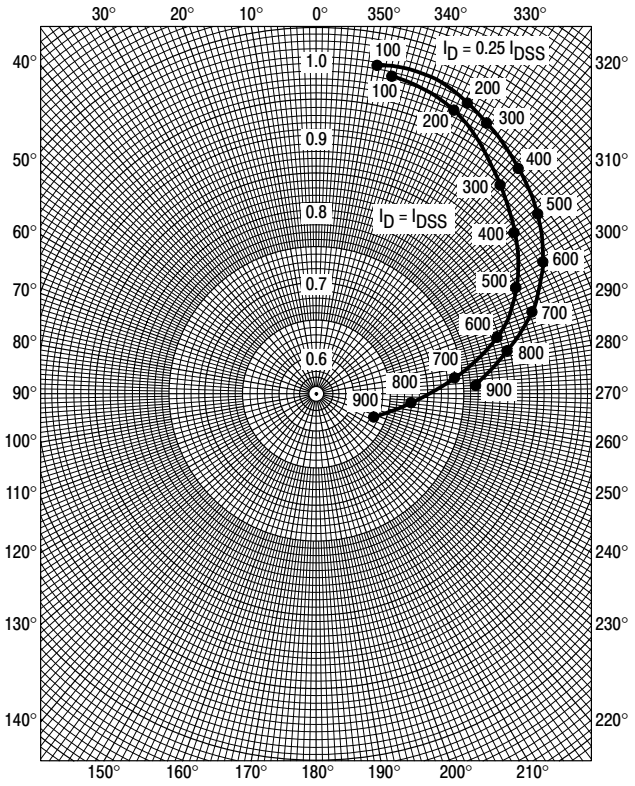


Figure 6. S_{11s}

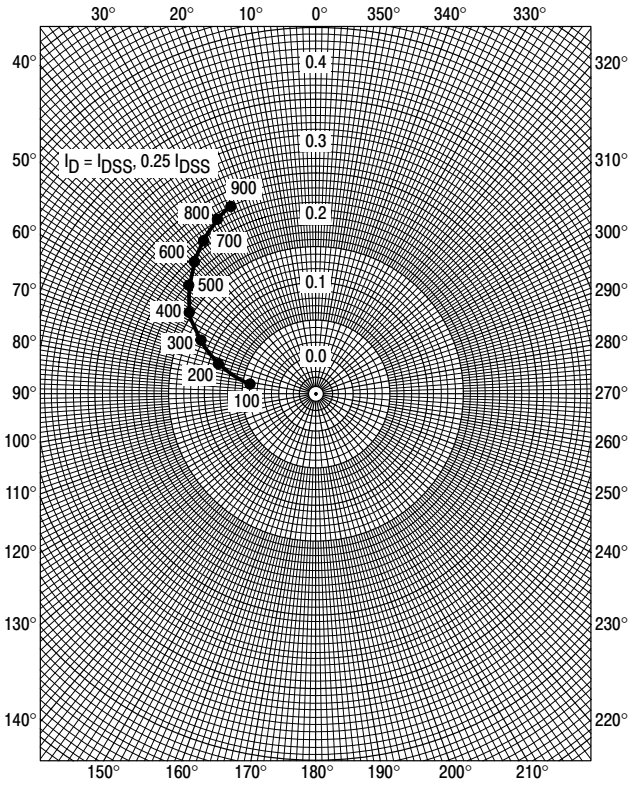


Figure 7. S_{12s}

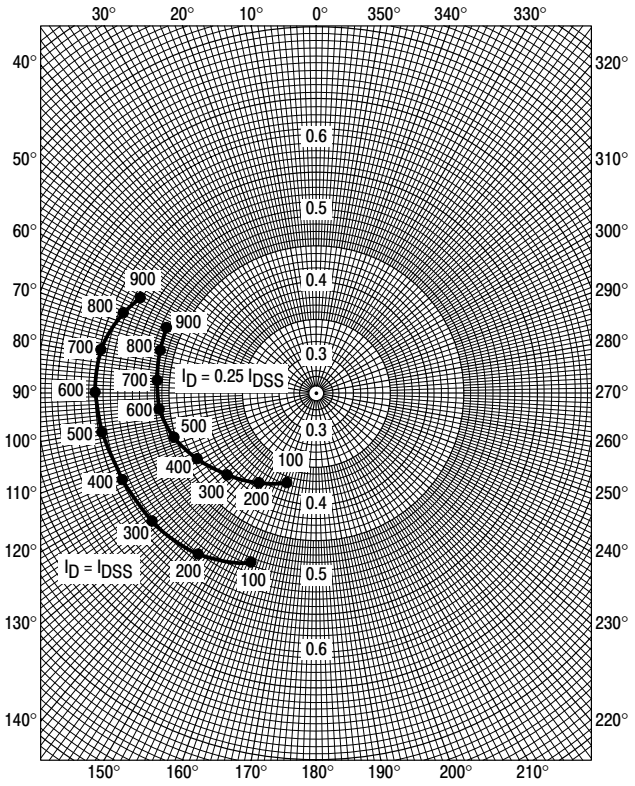


Figure 8. S_{21s}

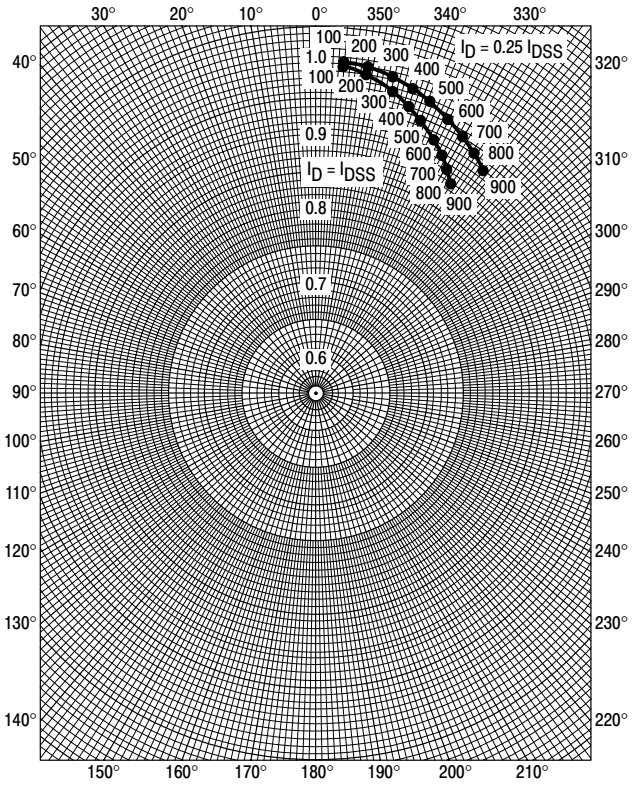


Figure 9. S_{22s}

COMMON GATE CHARACTERISTICS

ADMITTANCE PARAMETERS

(V_{DG} = 15 Vdc, $T_{channel}$ = 25°C)

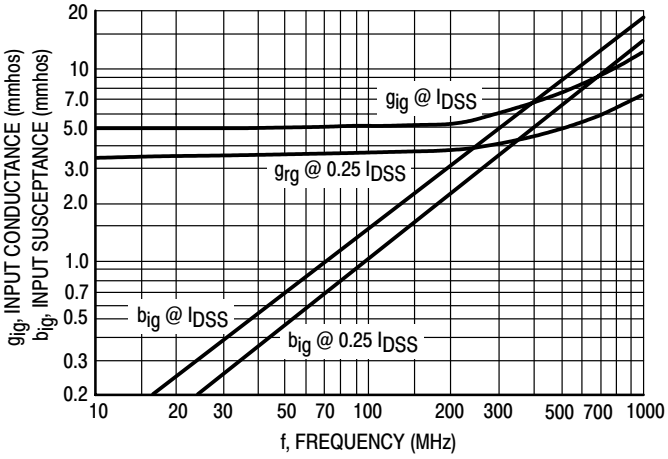


Figure 10. Input Admittance (y_{ig})

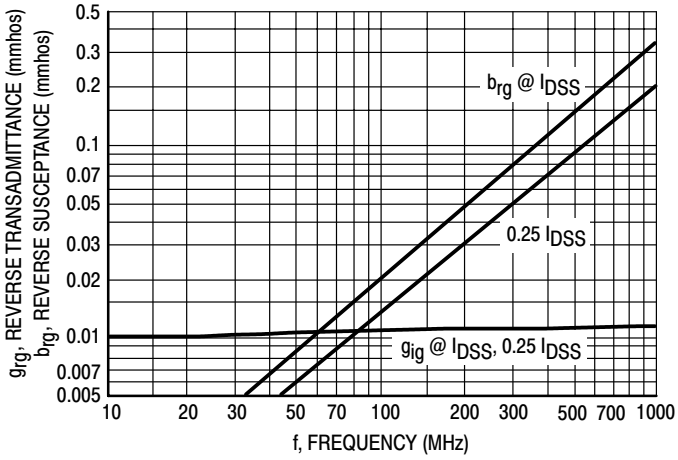


Figure 11. Reverse Transfer Admittance (y_{rg})

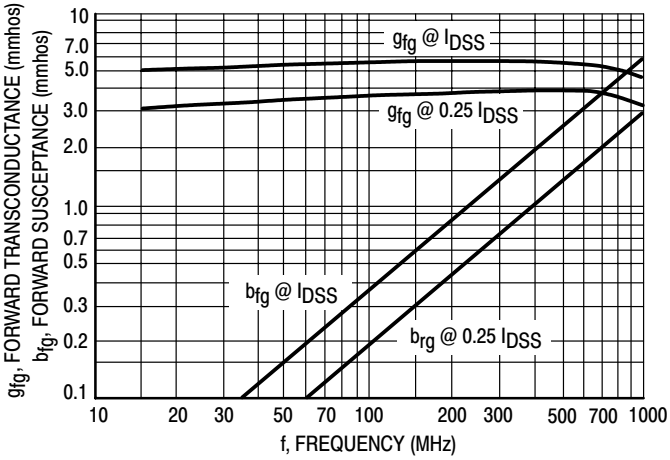


Figure 12. Forward Transfer Admittance (y_{fg})

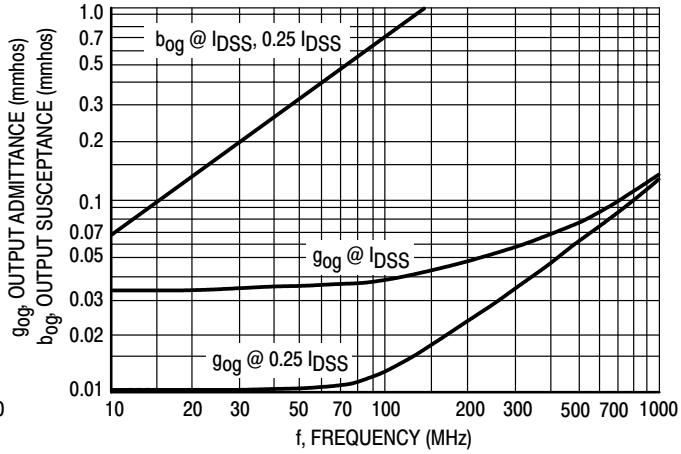


Figure 13. Output Admittance (y_{og})

COMMON GATE CHARACTERISTICS

S–PARAMETERS

(V_{DS} = 15 Vdc, $T_{channel}$ = 25°C, Data Points in MHz)

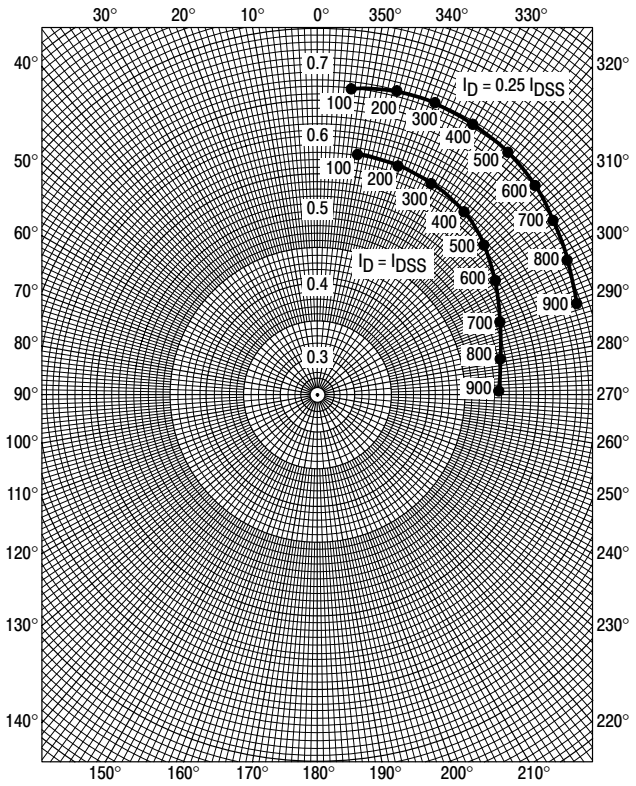


Figure 14. S_{11g}

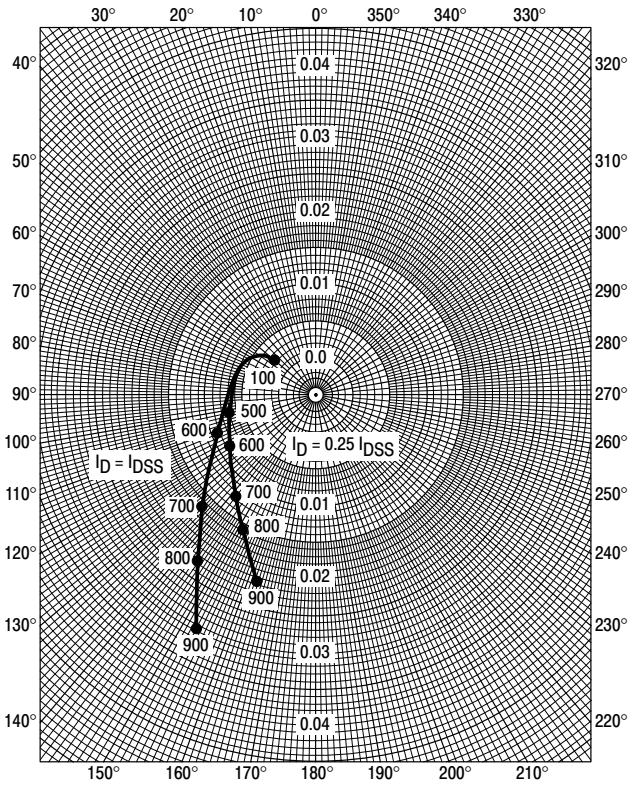


Figure 15. S_{12g}

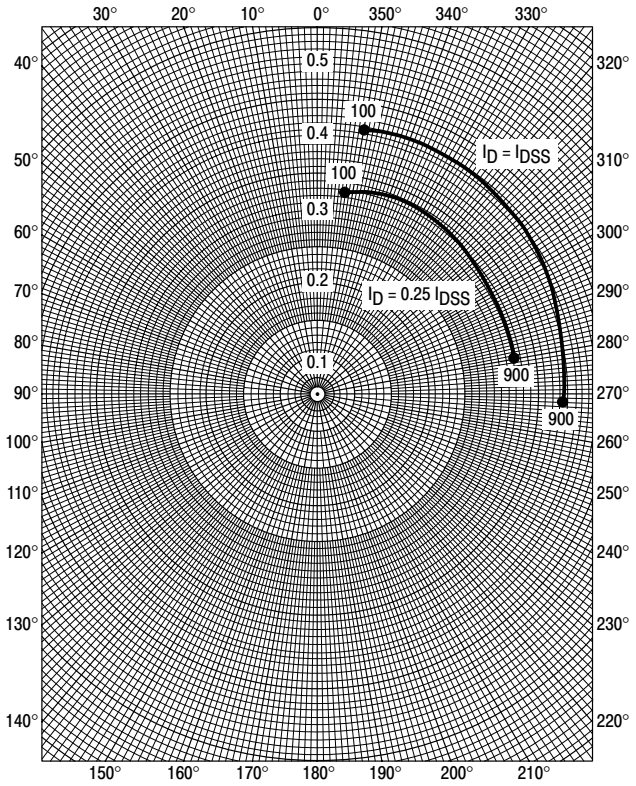


Figure 16. S_{21g}

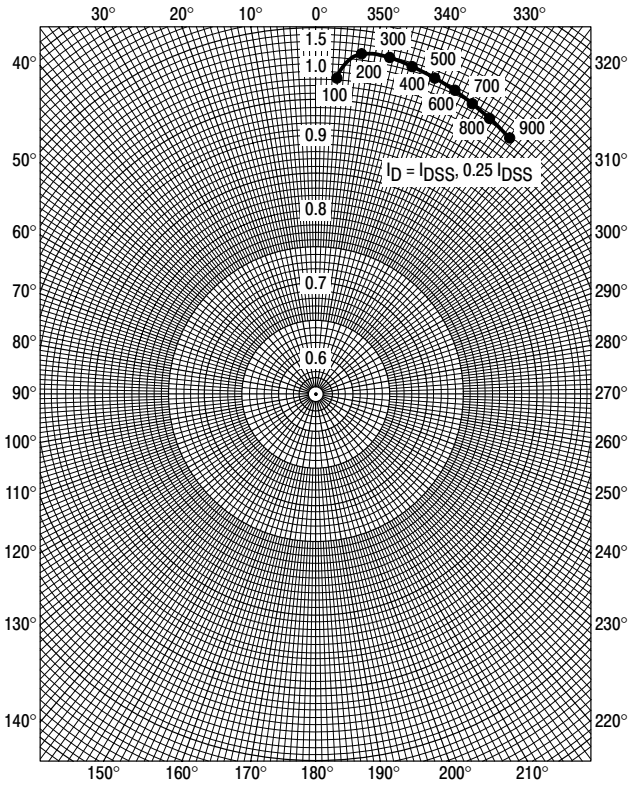
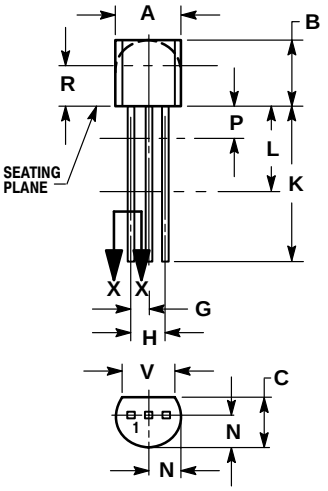
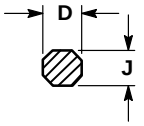


Figure 17. S_{22g}

PACKAGE DIMENSIONS

TO–92 (TO–226AA)
CASE 29–11
ISSUE AL





SECTION X–X

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

STYLE 5:
PIN 1. DRAIN
2. SOURCE
3. GATE

Notes

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